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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|--------------------------------|--|
| Product Status | Obsolete |
| Number of LABs/CLBs | 234720 |
| Number of Logic Elements/Cells | 622000 |
| Total RAM Bits | 51200000 |
| Number of I/O | 600 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1517-BBGA, FCBGA |
| Supplier Device Package | 1517-FBGA (40x40) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxma7n3f40c3n |

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Table 8 shows the transceiver power supply voltage requirements for various conditions.

Table 8. Transceiver Power Supply Voltage Requirements

| Conditions | Core Speed Grade | VCCR_GXB & VCCT_GXB (2) | VCCA_GXB | VCCH_GXB | Unit |
|--|-----------------------------------|-------------------------|----------|----------|------|
| If BOTH of the following conditions are true: | | 4.05 | | | |
| ■ Data rate > 10.3 Gbps. | All | 1.05 | | | |
| ■ DFE is used. | | | | | |
| If ANY of the following conditions are true ⁽¹⁾ : | | | 3.0 | | |
| ATX PLL is used. | | | | | |
| ■ Data rate > 6.5Gbps. | All | 1.0 | | | |
| ■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used. | | | | 1.5 | V |
| If ALL of the following | C1, C2, I2, and I3YY | 0.90 | 2.5 | | |
| conditions are true: ATX PLL is not used. | | | | | |
| ■ Data rate ≤ 6.5Gbps. | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85 | 2.5 | | |
| DFE, AEQ, and EyeQ are not used. | | | | | |

Notes to Table 8:

- (1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.
- (2) If the VCCR_GXB and VCCT_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR_GXB and VCCT_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.

For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

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Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices (1) (Part 2 of 2)

| | | | | Calibratio | n Accuracy | | |
|--|--|--|------------|------------|----------------|------------|------|
| Symbol | Description | Conditions | C1 | C2,I2 | C3,I3, I3YY | C4,I4 | Unit |
| 50-Ω R _S | Internal series termination with calibration (50- Ω setting) | V _{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % |
| $34\text{-}\Omega$ and $40\text{-}\Omega$ R_S | Internal series termination with calibration (34- Ω and 40- Ω setting) | V _{CCIO} = 1.5, 1.35, 1.25, 1.2 V | ±15 | ±15 | ±15 | ±15 | % |
| 48 - Ω , 60 - Ω , 80 - Ω , and 240 - Ω R _S | Internal series termination with calibration (48- Ω , 60- Ω , 80- Ω , and 240- Ω setting) | V _{CCIO} = 1.2 V | ±15 | ±15 | ±15 | ±15 | % |
| 50-Ω R _T | Internal parallel termination with calibration (50-Ω setting) | V _{CCIO} = 2.5, 1.8, 1.5, 1.2 V | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % |
| $\begin{array}{c} 20\text{-}\Omega,30\text{-}\Omega,\\ 40\text{-}\Omega,60\text{-}\Omega,\\ \text{and}\\ 120\text{-}\OmegaR_T \end{array}$ | Internal parallel termination with calibration (20- Ω , 30- Ω , 40- Ω , 60- Ω , and 120- Ω setting) | V _{CCIO} = 1.5, 1.35, 1.25 V | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % |
| 60- Ω and 120- Ω R _T | Internal parallel termination with calibration (60- Ω and 120- Ω setting) | V _{CCIO} = 1.2 | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % |
| $\begin{array}{c} \textbf{25-}\Omega \\ \textbf{R}_{S_left_shift} \end{array}$ | Internal left shift series termination with calibration (25- Ω R _{S_left_shift} setting) | V _{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % |

Note to Table 11:

Table 12 lists the Stratix V OCT without calibration resistance tolerance to PVT changes.

Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 1 of 2)

| | | | Resistance Tolerance | | | | | |
|-----------------------------|--|-----------------------------------|----------------------|-------|-----------------|--------|------|--|
| Symbol | Description | Conditions | C 1 | C2,I2 | C3, I3, I3YY | C4, I4 | Unit | |
| 25-Ω R, 50-Ω R _S | Internal series termination without calibration (25- Ω setting) | V _{CC10} = 3.0 and 2.5 V | ±30 | ±30 | ±40 | ±40 | % | |
| 25-Ω R _S | Internal series termination without calibration (25- Ω setting) | V _{CC10} = 1.8 and 1.5 V | ±30 | ±30 | ±40 | ±40 | % | |
| 25-Ω R _S | Internal series termination without calibration (25- Ω setting) | V _{CCIO} = 1.2 V | ±35 | ±35 | ±50 | ±50 | % | |

⁽¹⁾ OCT calibration accuracy is valid at the time of calibration only.

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| | | | Resistance Tolerance | | | | | |
|----------------------|--|-----------------------------------|----------------------|-------|-----------------|--------|------|--|
| Symbol | Description | Conditions | C1 | C2,I2 | C3, I3, I3YY | C4, I4 | Unit | |
| 50-Ω R _S | Internal series termination without calibration (50- Ω setting) | V _{CCIO} = 1.8 and 1.5 V | ±30 | ±30 | ±40 | ±40 | % | |
| 50-Ω R _S | Internal series termination without calibration (50- Ω setting) | V _{CCIO} = 1.2 V | ±35 | ±35 | ±50 | ±50 | % | |
| 100-Ω R _D | Internal differential termination (100-Ω setting) | V _{CCPD} = 2.5 V | ±25 | ±25 | ±25 | ±25 | % | |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

Equation 1. OCT Variation Without Recalibration for Stratix V Devices (1), (2), (3), (4), (5), (6)

$$R_{OCT} = R_{SCAL} \Big(1 + \langle \frac{dR}{dT} \times \Delta T \rangle \pm \langle \frac{dR}{dV} \times \Delta V \rangle \Big)$$

Notes to Equation 1:

- (1) The R_{OCT} value shows the range of OCT resistance with the variation of temperature and V_{CCIO} .
- (2) R_{SCAL} is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V_{CCIO} at power-up.
- (5) dR/dT is the percentage change of R_{SCAL} with temperature.
- (6) dR/dV is the percentage change of R_{SCAL} with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2) (1)

| Symbol | Description | V _{CCIO} (V) | Typical | Unit |
|--------|--|-----------------------|---------|------|
| | | 3.0 | 0.0297 | |
| | OCT variation with voltage without recalibration | 2.5 | 0.0344 | |
| dR/dV | | 1.8 | 0.0499 | %/mV |
| | | 1.5 | 0.0744 | |
| | | 1.2 | 0.1241 | |

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Table 18. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Stratix V Devices

| I/O Standard | | V _{CCIO} (V) | | | V _{REF} (V) | | V _{TT} (V) | | | |
|-------------------------|-------|-----------------------|-------|-----------------------------|-------------------------|-----------------------------|-----------------------------|----------------------------|-----------------------------|--|
| I/O Standard | Min | Тур | Max | Min | Тур | Max | Min | Тур | Мах | |
| SSTL-2 Class I, II | 2.375 | 2.5 | 2.625 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | V _{REF} – 0.04 | V_{REF} | V _{REF} + 0.04 | |
| SSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.833 | 0.9 | 0.969 | V _{REF} – 0.04 | V _{REF} | V _{REF} + 0.04 | |
| SSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * VCCIO | 0.51 * V _{CCIO} | |
| SSTL-135 Class I, II | 1.283 | 1.35 | 1.418 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | |
| SSTL-125 Class I, II | 1.19 | 1.25 | 1.26 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * VCCIO | 0.51 * V _{CCIO} | |
| SSTL-12 Class I, II | 1.14 | 1.20 | 1.26 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * VCCIO | 0.51 * V _{CCIO} | |
| HSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.85 | 0.9 | 0.95 | _ | V _{CCIO} /2 | _ | |
| HSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.68 | 0.75 | 0.9 | _ | V _{CCIO} /2 | _ | |
| HSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.47 * V _{CCIO} | 0.5 * V _{CCIO} | 0.53 * V _{CCIO} | _ | V _{CCIO} /2 | _ | |
| HSUL-12 | 1.14 | 1.2 | 1.3 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | _ | _ | _ | |

Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 1 of 2)

| I/O Standard | V _{IL(D(} | V _{IL(DC)} (V) | | _{C)} (V) | V _{IL(AC)} (V) | V _{IH(AC)} (V) | V _{OL} (V) | V _{OH} (V) | I (mA) | I _{oh} |
|-------------------------|--------------------|--------------------------|--------------------------|-------------------------|----------------------------|--------------------------|----------------------------|----------------------------|----------------------|-----------------|
| i/U Stanuaru | Min | Max | Min | Max | Max | Min | Max | Min | I _{ol} (mA) | (mA) |
| SSTL-2 Class I | -0.3 | V _{REF} – 0.15 | V _{REF} + 0.15 | V _{CCIO} + 0.3 | V _{REF} – 0.31 | V _{REF} + 0.31 | V _{TT} – 0.608 | V _{TT} + 0.608 | 8.1 | -8.1 |
| SSTL-2 Class II | -0.3 | V _{REF} – 0.15 | V _{REF} + 0.15 | V _{CCIO} + 0.3 | V _{REF} – 0.31 | V _{REF} + 0.31 | V _{TT} – 0.81 | V _{TT} + 0.81 | 16.2 | -16.2 |
| SSTL-18 Class I | -0.3 | V _{REF} – 0.125 | V _{REF} + 0.125 | V _{CCIO} + 0.3 | V _{REF} – 0.25 | V _{REF} + 0.25 | V _{TT} – 0.603 | V _{TT} + 0.603 | 6.7 | -6.7 |
| SSTL-18 Class II | -0.3 | V _{REF} – 0.125 | V _{REF} + 0.125 | V _{CCIO} + 0.3 | V _{REF} – 0.25 | V _{REF} + 0.25 | 0.28 | V _{CCIO} - 0.28 | 13.4 | -13.4 |
| SSTL-15 Class I | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} – 0.175 | V _{REF} + 0.175 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | 8 | -8 |
| SSTL-15 Class II | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} – 0.175 | V _{REF} + 0.175 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | 16 | -16 |
| SSTL-135 Class I, II | _ | V _{REF} – 0.09 | V _{REF} + 0.09 | _ | V _{REF} – 0.16 | V _{REF} + 0.16 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | _ | _ |
| SSTL-125 Class I, II | _ | V _{REF} – 0.85 | V _{REF} + 0.85 | _ | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | _ | _ |
| SSTL-12 Class I, II | _ | V _{REF} – 0.1 | V _{REF} + 0.1 | _ | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | _ | _ |

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Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as "Preliminary."
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

Table 23. Transceiver Specifications for Stratix V GX and GS Devices (1) (Part 1 of 7)

| Symbol/ | Conditions | Transceiver Speed Grade 1 | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit | |
|--|---|------------------------------|-------|------------------------------|----------|-------|------------------------------|-----------|---------|------------|----------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| Reference Clock | | | | | | | | | | | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V | PCML, | 1.4-V PCM | L, 1.5-V | PCML, | , 2.5-V PCN HCSL | 1L, Diffe | rential | LVPECL, L\ | /DS, and |
| RX reference clock pin 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | | | | | | |
| Input Reference Clock Frequency (CMU PLL) (8) | _ | 40 | _ | 710 | 40 | _ | 710 | 40 | _ | 710 | MHz |
| Input Reference Clock Frequency (ATX PLL) (8) | _ | 100 | _ | 710 | 100 | _ | 710 | 100 | _ | 710 | MHz |
| Rise time | Measure at ±60 mV of differential signal ⁽²⁶⁾ | _ | _ | 400 | _ | _ | 400 | _ | _ | 400 | ne |
| Fall time | Measure at ±60 mV of differential signal ⁽²⁶⁾ | _ | _ | 400 | _ | _ | 400 | _ | _ | 400 | ps |
| Duty cycle | _ | 45 | | 55 | 45 | _ | 55 | 45 | | 55 | % |
| Spread-spectrum modulating clock frequency | PCI Express® (PCIe®) | 30 | _ | 33 | 30 | _ | 33 | 30 | _ | 33 | kHz |

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Table 23. Transceiver Specifications for Stratix V GX and GS Devices (1) (Part 6 of 7)

| Symbol/ | Conditions | Trai | nsceive Grade | r Speed e 1 | Trar | sceive Grade | r Speed 2 | Transceiver Speed Grade 3 | | | Unit |
|---|--|------|------------------|-------------------------------|------|-----------------|-------------------------------|------------------------------|-----|-------------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| Inter-transceiver block transmitter channel-to- channel skew | xN PMA bonded mode | ı | ı | 500 | _ | ı | 500 | _ | _ | 500 | ps |
| CMU PLL | | | | | | | | | | | |
| Supported Data Range | _ | 600 | _ | 12500 | 600 | _ | 12500 | 600 | _ | 8500/ 10312.5 (24) | Mbps |
| t _{pll_powerdown} (15) | _ | 1 | _ | _ | 1 | _ | _ | 1 | _ | _ | μs |
| t _{pll_lock} (16) | _ | _ | _ | 10 | _ | _ | 10 | _ | _ | 10 | μs |
| ATX PLL | | | | | | | | | | | |
| | VCO post-divider L=2 | 8000 | | 14100 | 8000 | | 12500 | 8000 | _ | 8500/ 10312.5 (24) | Mbps |
| Currented Date | L=4 | 4000 | _ | 7050 | 4000 | _ | 6600 | 4000 | _ | 6600 | Mbps |
| Supported Data Rate Range | L=8 | 2000 | _ | 3525 | 2000 | _ | 3300 | 2000 | _ | 3300 | Mbps |
| G | L=8, Local/Central Clock Divider =2 | 1000 | _ | 1762.5 | 1000 | _ | 1762.5 | 1000 | _ | 1762.5 | Mbps |
| t _{pll_powerdown} (15) | _ | 1 | _ | _ | 1 | _ | _ | 1 | _ | _ | μs |
| t _{pll_lock} (16) | _ | | _ | 10 | _ | _ | 10 | _ | _ | 10 | μs |
| fPLL | | | | | | | | | | | |
| Supported Data Range | _ | 600 | _ | 3250/ 3125 ⁽²⁵⁾ | 600 | _ | 3250/ 3125 ⁽²⁵⁾ | 600 | _ | 3250/ 3125 ⁽²⁵⁾ | Mbps |
| t _{pll_powerdown} (15) | _ | 1 | _ | | 1 | _ | | 1 | | | μs |

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Table 27 shows the $\ensuremath{V_{OD}}$ settings for the GX channel.

Table 27. Typical V $_{\text{OD}}$ Setting for GX Channel, TX Termination = 100 Ω $^{(2)}$

| Symbol | V _{OD} Setting | V _{op} Value (mV) | V _{op} Setting | V _{op} Value (mV) |
|---------------------------------------|-------------------------|-------------------------------|-------------------------|-------------------------------|
| | 0 (1) | 0 | 32 | 640 |
| | 1 (1) | 20 | 33 | 660 |
| | 2 (1) | 40 | 34 | 680 |
| | 3 (1) | 60 | 35 | 700 |
| | 4 (1) | 80 | 36 | 720 |
| | 5 ⁽¹⁾ | 100 | 37 | 740 |
| | 6 | 120 | 38 | 760 |
| | 7 | 140 | 39 | 780 |
| | 8 | 160 | 40 | 800 |
| | 9 | 180 | 41 | 820 |
| | 10 | 200 | 42 | 840 |
| | 11 | 220 | 43 | 860 |
| | 12 | 240 | 44 | 880 |
| | 13 | 260 | 45 | 900 |
| | 14 | 280 | 46 | 920 |
| V op differential peak to peak | 15 | 300 | 47 | 940 |
| typical ⁽³⁾ | 16 | 320 | 48 | 960 |
| | 17 | 340 | 49 | 980 |
| | 18 | 360 | 50 | 1000 |
| | 19 | 380 | 51 | 1020 |
| | 20 | 400 | 52 | 1040 |
| | 21 | 420 | 53 | 1060 |
| | 22 | 440 | 54 | 1080 |
| | 23 | 460 | 55 | 1100 |
| | 24 | 480 | 56 | 1120 |
| | 25 | 500 | 57 | 1140 |
| | 26 | 520 | 58 | 1160 |
| | 27 | 540 | 59 | 1180 |
| | 28 | 560 | 60 | 1200 |
| | 29 | 580 | 61 | 1220 |
| | 30 | 600 | 62 | 1240 |
| | 31 | 620 | 63 | 1260 |

Note to Table 27:

- (1) If TX termination resistance = 100Ω , this VOD setting is illegal.
- (2) The tolerance is +/-20% for all VOD settings except for settings 2 and below.
- (3) Refer to Figure 2.

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Figure 2 shows the differential transmitter output waveform.

Figure 2. Differential Transmitter Output Waveform

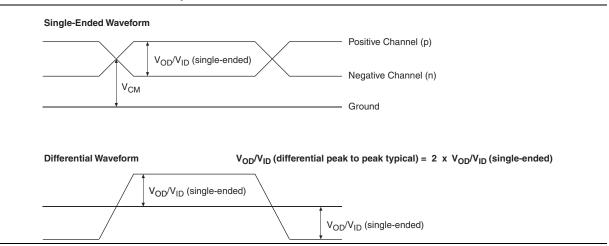


Figure 3 shows the Stratix V AC gain curves for GX channels.

Figure 3. AC Gain Curves for GX Channels (full bandwidth)



Stratix V GT devices contain both GX and GT channels. All transceiver specifications for the GX channels not listed in Table 28 are the same as those listed in Table 23.

Table 28 lists the Stratix V GT transceiver specifications.

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Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5) $^{(1)}$

| Symbol/ | Conditions | 5 | Transceive Speed Grade | | | Transceiver Speed Grade 3 | | Unit |
|--|--|-----------|---------------------------|--------------|------------------------|------------------------------|--------------|------------|
| Description | | Min | Тур | Max | Min | Тур | Max | |
| Reference Clock | • | • | • | • | • | • | • | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V PCN | /IL, 1.4-V PC | ML, 1.5-V P | CML, 2.5-V and HCSL | PCML, Diffe | rential LVPE | ECL, LVDS, |
| Standards | RX reference clock pin | | 1.4-V PCML | ., 1.5-V PCN | IL, 2.5-V PC | ML, LVPEC | L, and LVDS | ; |
| Input Reference Clock Frequency (CMU PLL) ⁽⁶⁾ | _ | 40 | _ | 710 | 40 | _ | 710 | MHz |
| Input Reference Clock Frequency (ATX PLL) (6) | _ | 100 | _ | 710 | 100 | _ | 710 | MHz |
| Rise time | 20% to 80% | _ | _ | 400 | _ | _ | 400 | |
| Fall time | 80% to 20% | _ | _ | 400 | _ | <u> </u> | 400 | ps |
| Duty cycle | _ | 45 | _ | 55 | 45 | _ | 55 | % |
| Spread-spectrum modulating clock frequency | PCI Express (PCIe) | 30 | _ | 33 | 30 | _ | 33 | kHz |
| Spread-spectrum downspread | PCle | _ | 0 to -0.5 | _ | _ | 0 to -0.5 | _ | % |
| On-chip termination resistors (19) | _ | _ | 100 | _ | _ | 100 | _ | Ω |
| Absolute V _{MAX} (3) | Dedicated reference clock pin | _ | _ | 1.6 | _ | _ | 1.6 | V |
| | RX reference clock pin | _ | _ | 1.2 | _ | _ | 1.2 | |
| Absolute V _{MIN} | _ | -0.4 | _ | _ | -0.4 | _ | _ | V |
| Peak-to-peak differential input voltage | _ | 200 | _ | 1600 | 200 | _ | 1600 | mV |
| V _{ICM} (AC coupled) | Dedicated reference clock pin | | 1050/1000 | 2) | | 1050/1000 | mV | |
| | RX reference clock pin | 1 | .0/0.9/0.85 | (22) | 1 | .0/0.9/0.85 | (22) | V |
| V _{ICM} (DC coupled) | HCSL I/O standard for PCIe reference clock | 250 | _ | 550 | 250 | _ | 550 | mV |

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Figure 4 shows the differential transmitter output waveform.

Figure 4. Differential Transmitter/Receiver Output/Input Waveform

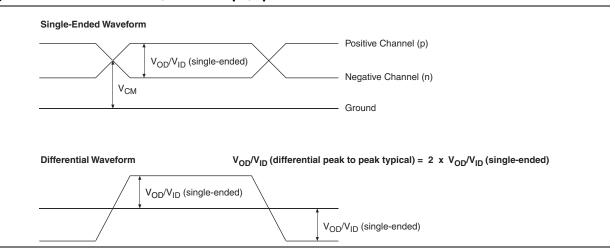


Figure 5 shows the Stratix V AC gain curves for GT channels.

Figure 5. AC Gain Curves for GT Channels

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Table 31. PLL Specifications for Stratix V Devices (Part 2 of 3)

| Symbol | Parameter | Min | Тур | Max | Unit |
|--|---|------|---------|--|-----------|
| → (3) (4) | Input clock cycle-to-cycle jitter (f _{REF} ≥ 100 MHz) | _ | _ | 0.15 | UI (p-p) |
| t _{INCCJ} (3), (4) | Input clock cycle-to-cycle jitter (f _{REF} < 100 MHz) | -750 | | +750 | ps (p-p) |
| + (5) | Period Jitter for dedicated clock output ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 175 ⁽¹⁾ | ps (p-p) |
| t _{OUTPJ_DC} (5) | Period Jitter for dedicated clock output (f _{OUT} < 100 MHz) | _ | _ | 17.5 ⁽¹⁾ | mUI (p-p) |
| + (5) | Period Jitter for dedicated clock output in fractional PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{FOUTPJ_DC} (5) | Period Jitter for dedicated clock output in fractional PLL (f _{OUT} < 100 MHz) | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| + (5) | Cycle-to-Cycle Jitter for a dedicated clock output $(f_{OUT} \ge 100 \text{ MHz})$ | _ | _ | 175 | ps (p-p) |
| t _{outccj_dc} (5) | Cycle-to-Cycle Jitter for a dedicated clock output (f _{OUT} < 100 MHz) | _ | _ | 17.5 | mUI (p-p) |
| + (5) | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{FOUTCCJ_DC} ⁽⁵⁾ | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL (f _{OUT} < 100 MHz)+ | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| t _{OUTPJ_IO} (5), | Period Jitter for a clock output on a regular I/O in integer PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 600 | ps (p-p) |
| (8) | Period Jitter for a clock output on a regular I/O (f _{OUT} < 100 MHz) | _ | _ | 60 | mUI (p-p) |
| t _{FOUTPJ 10} (5), | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 600 (10) | ps (p-p) |
| (8), (11) | Period Jitter for a clock output on a regular I/O in fractional PLL (f_{OUT} < 100 MHz) | _ | _ | 60 (10) | mUI (p-p) |
| t _{outccj_10} (5), | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL ($f_{OUT} \ge 100$ MHz) | _ | _ | 600 | ps (p-p) |
| (8) | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} < 100 MHz) | _ | _ | 60 (10) | mUI (p-p) |
| t _{ғоитссу_10} | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \ge 100$ MHz) | _ | _ | 600 (10) | ps (p-p) |
| (8), (11) | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL (f_{OUT} < 100 MHz) | _ | _ | 60 | mUI (p-p) |
| t _{CASC_OUTPJ_DC} | Period Jitter for a dedicated clock output in cascaded PLLs ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 175 | ps (p-p) |
| (5), (6) | Period Jitter for a dedicated clock output in cascaded PLLs (f _{OUT} < 100 MHz) | _ | _ | 17.5 | mUI (p-p) |
| f _{DRIFT} | Frequency drift after PFDENA is disabled for a duration of 100 μs | _ | _ | ±10 | % |
| dK _{BIT} | Bit number of Delta Sigma Modulator (DSM) | 8 | 24 | 32 | Bits |
| k _{VALUE} | Numerator of Fraction | 128 | 8388608 | 2147483648 | _ |

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Periphery Performance

This section describes periphery performance, including high-speed I/O and external memory interface.

I/O performance supports several system interfaces, such as the **LVDS** high-speed I/O interface, external memory interface, and the **PCI/PCI-X** bus interface. General-purpose I/O standards such as 3.3-, 2.5-, 1.8-, and 1.5-**LVTTL/LVCMOS** are capable of a typical 167 MHz and 1.2-**LVCMOS** at 100 MHz interfacing frequency with a 10 pF load.



The actual achievable frequency depends on design- and system-specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

High-Speed I/O Specification

Table 36 lists high-speed I/O timing for Stratix V devices.

Table 36. High-Speed I/O Specifications for Stratix V Devices (1), (2) (Part 1 of 4)

| _ | | | | | | | | | | | | | | |
|--|---------------------------------------|-----|-----|-----|-----|--------|--------|-----|---------|--------------------|-----|------|------------|-------|
| Cumbal | Conditions | | C1 | | C2, | C2L, I | 2, I2L | C3, | 13, I3L | 3, I3L, I3YY C4,I4 | 4 | Unit | | |
| Symbol | Conuntions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Uilit |
| f _{HSCLK_in} (input clock frequency) True Differential I/O Standards | Clock boost factor W = 1 to 40 (4) | 5 | | 800 | 5 | _ | 800 | 5 | | 625 | 5 | | 525 | MHz |
| f _{HSCLK_in} (input clock frequency) Single Ended I/O Standards ⁽³⁾ | Clock boost factor W = 1 to 40 (4) | 5 | | 800 | 5 | _ | 800 | 5 | | 625 | 5 | | 525 | MHz |
| f _{HSCLK_in} (input clock frequency) Single Ended I/O Standards | Clock boost factor W = 1 to 40 (4) | 5 | | 520 | 5 | _ | 520 | 5 | | 420 | 5 | | 420 | MHz |
| f _{HSCLK_OUT} (output clock frequency) | _ | 5 | | 800 | 5 | _ | 800 | 5 | | 625 (5) | 5 | | 525 (5) | MHz |

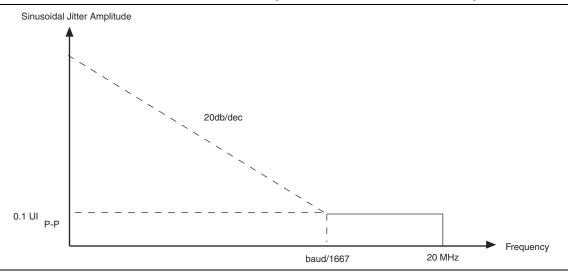
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Table 38. LVDS Soft-CDR/DPA Sinusoidal Jitter Mask Values for a Data Rate \geq 1.25 Gbps

| Jitter F | requency (Hz) | Sinusoidal Jitter (UI) |
|----------|---------------|------------------------|
| F1 | 10,000 | 25.000 |
| F2 | 17,565 | 25.000 |
| F3 | 1,493,000 | 0.350 |
| F4 | 50,000,000 | 0.350 |

Figure 9 shows the **LVDS** soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate < 1.25 Gbps.

Figure 9. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate < 1.25 Gbps



DLL Range, DQS Logic Block, and Memory Output Clock Jitter Specifications

Table 39 lists the DLL range specification for Stratix V devices. The DLL is always in 8-tap mode in Stratix V devices.

Table 39. DLL Range Specifications for Stratix V Devices (1)

| C1 | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|---------|------------------|-------------------|---------|------|
| 300-933 | 300-933 | 300-890 | 300-890 | MHz |

Note to Table 39:

(1) Stratix V devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Table 40 lists the DQS phase offset delay per stage for Stratix V devices.

Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices (1), (2) (Part 1 of 2)

| Speed Grade | Min | Max | Unit |
|------------------|-----|-----|------|
| C1 | 8 | 14 | ps |
| C2, C2L, I2, I2L | 8 | 14 | ps |
| C3,I3, I3L, I3YY | 8 | 15 | ps |

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Table 42. Memory Output Clock Jitter Specification for Stratix V Devices (1), (Part 2 of 2) (2), (3)

| Clock Network | Parameter Symb | | C | 1 | C2, C2L | , I2, I2L | C3, I3 | | C4 | ,14 | Unit |
|------------------|------------------------------|------------------------|-------|------|---------|-----------|--------|-----|-----|-----|------|
| NELWURK | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| | Clock period jitter | t _{JIT(per)} | -25 | 25 | -25 | 25 | -30 | 30 | -35 | 35 | ps |
| PHY Clock | Cycle-to-cycle period jitter | t _{JIT(cc)} | -50 | 50 | -50 | 50 | -60 | 60 | -70 | 70 | ps |
| | Duty cycle jitter | t _{JIT(duty)} | -37.5 | 37.5 | -37.5 | 37.5 | -45 | 45 | -56 | 56 | ps |

Notes to Table 42:

- (1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.
- (2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.
- (3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

OCT Calibration Block Specifications

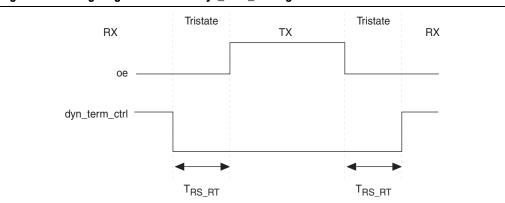
Table 43 lists the OCT calibration block specifications for Stratix V devices.

Table 43. OCT Calibration Block Specifications for Stratix V Devices

| Symbol | Description | Min | Тур | Max | Unit |
|-----------------------|--|-----|------|-----|--------|
| OCTUSRCLK | Clock required by the OCT calibration blocks | | _ | 20 | MHz |
| T _{OCTCAL} | Number of OCTUSRCLK clock cycles required for OCT $\ensuremath{R}_{\ensuremath{S}}/\ensuremath{R}_{\ensuremath{T}}$ calibration | _ | 1000 | _ | Cycles |
| T _{OCTSHIFT} | Number of OCTUSRCLK clock cycles required for the OCT code to shift out | _ | 32 | _ | Cycles |
| T _{RS_RT} | Time required between the $\mathtt{dyn_term_ctrl}$ and oe signal transitions in a bidirectional I/O buffer to dynamically switch between OCT R_S and R_T (Figure 10) | _ | 2.5 | _ | ns |

Figure 10 shows the timing diagram for the oe and dyn term ctrl signals.

Figure 10. Timing Diagram for oe and dyn_term_ctrl Signals



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Table 48. Minimum Configuration Time Estimation for Stratix V Devices

| | Member | | Active Serial (1) |) | Fast Passive Parallel (2) | | | |
|---------|--------|-------|-------------------|------------------------|---------------------------|------------|------------------------|--|
| Variant | Code | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) | |
| | D3 | 4 | 100 | 0.344 | 32 | 100 | 0.043 | |
| | D4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | |
| GS | | 4 | 100 | 0.344 | 32 | 100 | 0.043 | |
| us | D5 | 4 | 100 | 0.534 | 32 | 100 | 0.067 | |
| | D6 | 4 | 100 | 0.741 | 32 | 100 | 0.093 | |
| | D8 | 4 | 100 | 0.741 | 32 | 100 | 0.093 | |
| E | E9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |
| | EB | 4 | 100 | 0.857 | 32 | 100 | 0.107 | |

Notes to Table 48:

Fast Passive Parallel Configuration Timing

This section describes the fast passive parallel (FPP) configuration timing parameters for Stratix V devices.

DCLK-to-DATA[] Ratio for FPP Configuration

FPP configuration requires a different DCLK-to-DATA[] ratio when you enable the design security, decompression, or both features. Table 49 lists the DCLK-to-DATA[] ratio for each combination.

Table 49. DCLK-to-DATA[] Ratio (1) (Part 1 of 2)

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|-------------------------|---------------|-----------------|-------------------------|
| | Disabled | Disabled | 1 |
| FPP ×8 | Disabled | Enabled | 1 |
| | Enabled | Disabled | 2 |
| | Enabled | Enabled | 2 |
| | Disabled | Disabled | 1 |
| FPP ×16 | Disabled | Enabled | 2 |
| ree × 10 | Enabled | Disabled | 4 |
| | Enabled | Enabled | 4 |

⁽¹⁾ DCLK frequency of 100 MHz using external CLKUSR.

⁽²⁾ Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

Page 58 Configuration Specification

Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA[] ratio is 1.

Table 50. FPP Timing Parameters for Stratix V Devices (1)

| Symbol | Parameter | Minimum | Maximum | Units |
|------------------------|---|--|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | _ | 600 | ns |
| t _{CF2ST0} | nconfig low to nstatus low | _ | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | _ | μS |
| t _{STATUS} | nstatus low pulse width | 268 | 1,506 ⁽²⁾ | μ\$ |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | _ | 1,506 ⁽³⁾ | μ\$ |
| t _{CF2CK} (6) | nCONFIG high to first rising edge on DCLK | 1,506 | _ | μ\$ |
| t _{ST2CK} (6) | nSTATUS high to first rising edge of DCLK | 2 | _ | μ\$ |
| t _{DSU} | DATA[] setup time before rising edge on DCLK | 5.5 | _ | ns |
| t _{DH} | DATA[] hold time after rising edge on DCLK | 0 | _ | ns |
| t _{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | _ | S |
| t _{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | _ | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | _ | S |
| f | DCLK frequency (FPP ×8/×16) | _ | 125 | MHz |
| f _{MAX} | DCLK frequency (FPP ×32) | _ | 100 | MHz |
| t _{CD2UM} | CONF_DONE high to user mode (4) | 175 | 437 | μS |
| + | GOVER DOVER high to GUVERN anabled | 4 × maximum | | |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | DCLK period | _ | _ |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t _{CD2CU} + (8576 × CLKUSR period) ⁽⁵⁾ | _ | _ |

Notes to Table 50:

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nstatus low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

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Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is more than 1.

Table 51. FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is >1 $^{(1)}$

| Symbol | Parameter | Minimum | Maximum | Units |
|------------------------|---|--|----------------------|-------|
| t _{CF2CD} | nconfig low to conf_done low | _ | 600 | ns |
| t _{CF2ST0} | nconfig low to nstatus low | _ | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | _ | μS |
| t _{STATUS} | nstatus low pulse width | 268 | 1,506 ⁽²⁾ | μS |
| t _{CF2ST1} | nconfig high to nstatus high | _ | 1,506 ⁽²⁾ | μS |
| t _{CF2CK} (5) | nconfig high to first rising edge on DCLK | 1,506 | _ | μS |
| t _{ST2CK} (5) | nstatus high to first rising edge of DCLK | 2 | _ | μS |
| t _{DSU} | DATA[] setup time before rising edge on DCLK | 5.5 | _ | ns |
| t _{DH} | DATA[] hold time after rising edge on DCLK | N-1/f _{DCLK} ⁽⁵⁾ | _ | S |
| t _{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | _ | S |
| t _{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | _ | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | _ | S |
| f | DCLK frequency (FPP ×8/×16) | _ | 125 | MHz |
| f _{MAX} | DCLK frequency (FPP ×32) | _ | 100 | MHz |
| t _R | Input rise time | _ | 40 | ns |
| t _F | Input fall time | _ | 40 | ns |
| t _{CD2UM} | CONF_DONE high to user mode (3) | 175 | 437 | μS |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | _ | _ |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t _{CD2CU} + (8576 × CLKUSR period) ⁽⁴⁾ | _ | _ |

Notes to Table 51:

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nconfig or nstatus low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (5) N is the DCLK-to-DATA ratio and f_{DCLK} is the DCLK frequency the system is operating.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Page 64 I/O Timing

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

Table 56. Remote System Upgrade Circuitry Timing Specifications

| Parameter | Minimum | Maximum | Unit | | |
|------------------------------|---------|---------|------|--|--|
| t _{RU_nCONFIG} (1) | 250 | _ | ns | | |
| t _{RU_nRSTIMER} (2) | 250 | _ | ns | | |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units | | |
|---------|---------|---------|-------|--|--|
| 5.3 | 7.9 | 12.5 | MHz | | |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.

You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Doromotor | Avoilable | Min | Fast Model | | Slow Model | | | | | | | |
|---------------|-----------|------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
| Parameter (1) | | Offset (2) | Industrial | Commercial | C1 | C2 | C3 | C4 | 12 | 13, 13YY | 14 | Unit |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |

Page 66 Glossary

Table 60. Glossary (Part 2 of 4)

| Letter | Subject | Definitions | | |
|------------------|-------------------------------|--|--|--|
| G | | | | |
| Н | _ | _ | | |
| 1 | | | | |
| J | JTAG Timing Specifications | High-speed I/O block—Deserialization factor (width of parallel data bus). JTAG Timing Specifications: TMS TDI TCK TJPSU TJ | | |
| K L M N | _ | | | |
| P | PLL Specifications | Diagram of PLL Specifications (1) Switchover CLKOUT Pins Four Core Clock Reconfigurable in User Mode External Feedback Note: (1) Core Clock can only be fed by dedicated clock input pins or PLL outputs. | | |
| Q | _ | —————————————————————————————————————— | | |
| R | R _L | Receiver differential input discrete resistor (external to the Stratix V device). | | |
| | L | 1 | | |

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